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Data sheet

SAW RF filter Automotive telematics GNSS L2

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- 1 Application
- GNSS L2: 1223 MHz (pass band 52 MHz)
- Low insertion attenuation
- External matching circuitry required

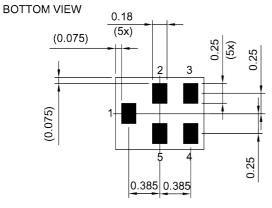
2 Features

- Package size 1.1±0.1 mm × 0.9±0.1 mm
- Package height 0.45 mm (max.)
- Approximate weight 2 mg
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Filter surface passivated
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 2a (MSL2a)
- AEC-Q200 qualified component family (Grade 1: -40 °C to +125 °C)



Figure 1: Picture of component with example of product marking.

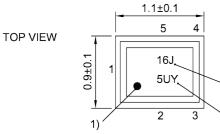
3 Package



Pad and pitch tolerance ±0.05

SIDE VIEW



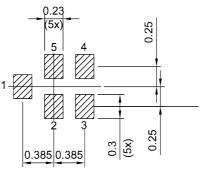


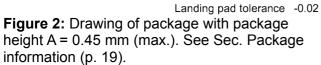
- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number

3)

2)

Land pattern THRU VIEW





- 1 Input
- 4 Output
- 2, 3 Ground



5 **Matching circuit**

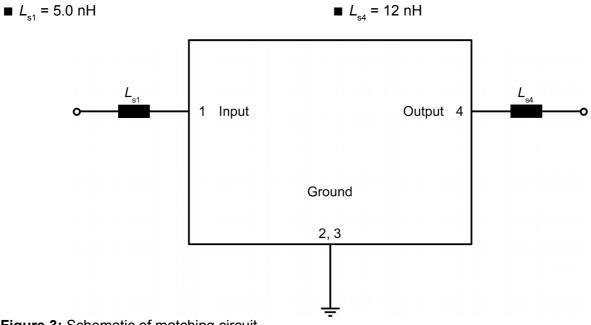


Figure 3: Schematic of matching circuit.

6 Characteristics

Temperature range for specification	T _{SPEC}	= −40 °C +105 °C
Input terminating impedance	Z	= 50 Ω + 5.0 nH ¹⁾
Output terminating impedance	Z _{OUT}	= 50 Ω + 12 nH ¹⁾

Characteristics				min. for $T_{\rm SPEC}$	typ. @ +25 °C	max. for $T_{_{\rm SPEC}}$	
Center frequency			f _c				
	1197 1249	MHz		_	1223	_	MHz
Maximum insertion attenuation			α _{max}				
	1197 1249	MHz		_	1.0	1.8	dB
Amplitude ripple (p-p)			Δα				
	1197 1249	MHz		—	0.5	1.0	dB
Group delay ripple ²⁾			$\Delta au_{ m var}$				
	1197 1217	MHz		_	5	8	ns
	1217 1237	MHz		—	3	5	ns
	1242 1249	MHz		—	3	5	ns
Maximum VSWR			$VSWR_{max}$				
@ input port	1197 1249	MHz		—	1.7	2.2	
@ output port	1197 1249	MHz		—	1.7	2.2	
Minimum attenuation			$\alpha_{_{min}}$				
	100 1000	MHz		35	40	—	dB
	1000 1144	MHz		20	32	—	dB
	1300 1350	MHz		20	33	—	dB
	1350 1750	MHz		25	30	—	dB
	1750 3000	MHz		30	34	—	dB
	3000 4500	MHz		40	47	—	dB
	4500 6000	MHz		40	57	—	dB

¹⁾ See Sec. Matching circuit (p. 6).

²⁾ Aperture 1.0 MHz.

7 **Maximum ratings**

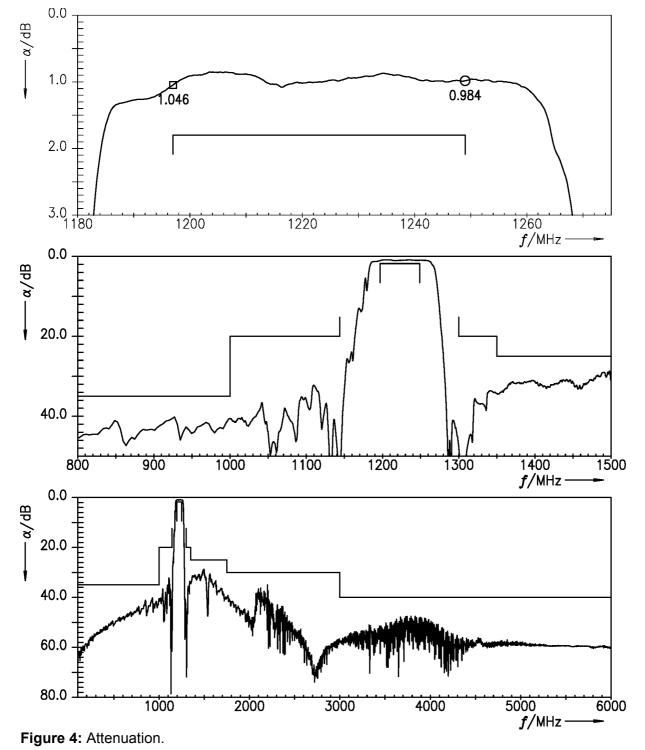
Operable temperature	T _{OP} = −40 °C +125 °C	
Storage temperature	<i>T</i> _{STG} ¹⁾ = −40 °C +125 °C	
DC voltage	$ V_{\rm DC} ^{2} = 0 V (max.)$	
Input power @ input port	P _{IN} = 15 dBm	Continuous wave for 5000 h @ 55 °C.

Not valid for packaging material. Storage temperature for packaging material is -25 °C to +40 °C. In case of applied DC voltage blocking capacitors are mandatory. 1)

2)



8 Transmission coefficient





□ = 1197.0 O = 1249.0

Z_{IN}=50 Ω

9 Reflection coefficients

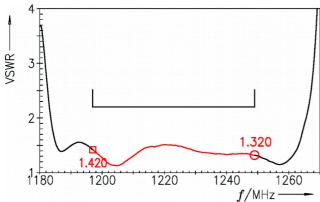
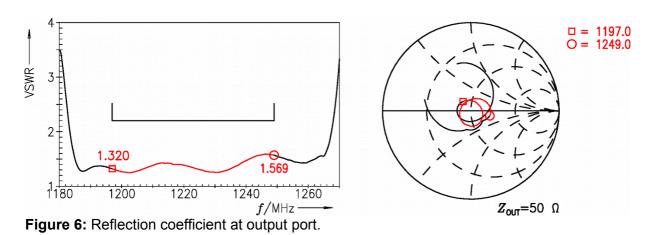


Figure 5: Reflection coefficient at input port.





10 Group delay

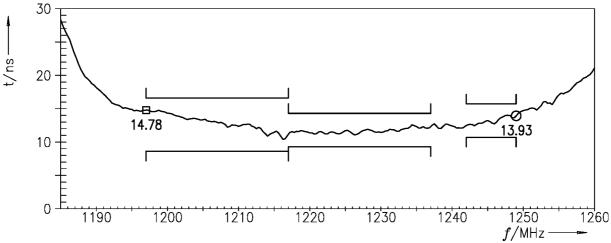
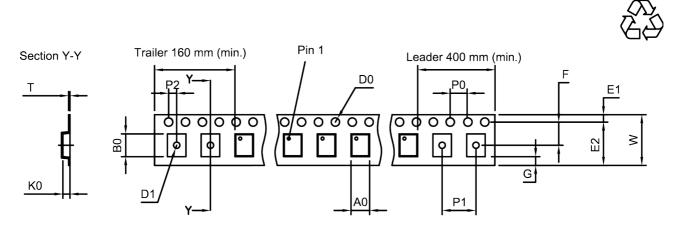


Figure 7: Group delay ripple.



11 Packing material

11.1 Tape



User direction of unreeling

Figure 8: Drawing of tape (first-angle projection) for illustration only and not to scale. The valid tape dimensions are listed in Table 1.

 A₀
 1.02±0.05 mm

 B₀
 1.22±0.05 mm

 D₀
 1.55±0.05 mm

 D₁
 0.55±0.1 mm

 E₁
 1.75±0.1 mm

E2	6.25 mm (min.)
F	3.5±0.05 mm
G	-
K ₀	0.6±0.05 mm
P ₀	4.0±0.1 mm

P ₁	2.0±0.1 mm
P ₂	2.0±0.05 mm
Т	0.25±0.03 mm
W	8.0+0.3/-0.1 mm

Table 1: Tape dimensions.



11.2 Reel with diameter of 180 mm

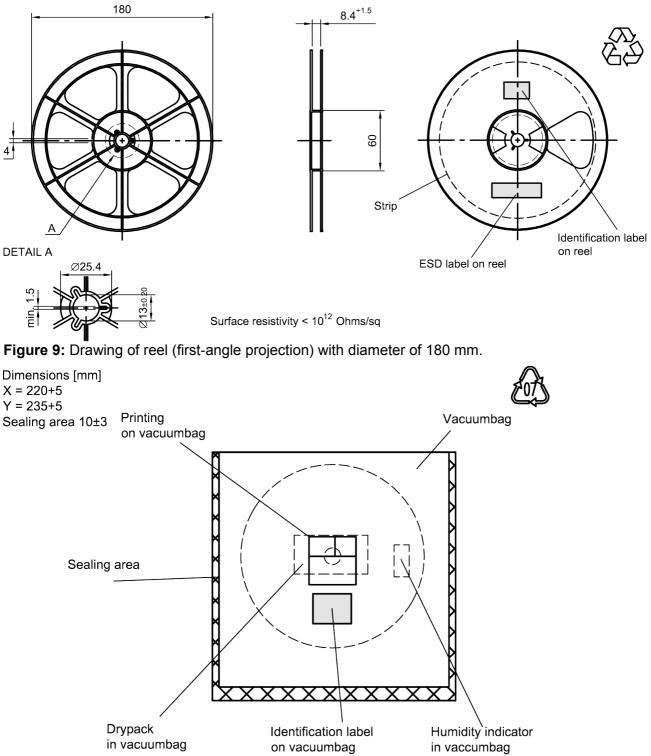


Figure 10: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

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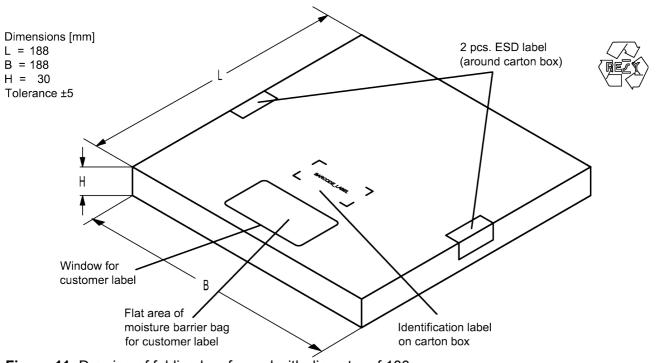


Figure 11: Drawing of folding box for reel with diameter of 180 mm.

12 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:

The 4 digit type number is encoded by a special	of the ordering code, BASE32 code into a 3 digit marking.	e.g., B3xxxxB <u>1234</u> xxxx,
	type number marking on device \Rightarrow $32^{1} + 18 (=J) \times 32^{0} =$ roduct type B2632 is 2J8.	in decimal code. 1234 1234

■ Lot number:

The last 5 digits of the lot number, 12345, e.g., are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device **5UY**

decoding lot number marking on device		in decimal code.
5UY	=>	12345
5 x 47 ² + 27 (=U) x 47 ¹ + 31 (=Y) x 47 ⁰	=	12345

Adopted BASE32 code for type number			
Decimal	Base32	Decimal	Base32
value	code	value	code
0	0	16	G
1	1	17	Н
2	2	18	J
3	3	19	K
4	4	20	М
5	5	21	N
6	6	22	Р
7	7	23	Q
8	8	24	R
9	9	25	S
10	А	26	Т
11	В	27	V
12	С	28	W
13	D	29	Х
14	E	30	Y
15	F	31	Z

Adopted BASE47 code for lot number			
Decimal	Base47	Decimal	Base47
value	code	value	code
0	0	24	R
1	1	25	S
2	2	26	Т
3	3	27	U
4	4	28	V
5	5	29	W
6	6	30	Х
7	7	31	Y
8	8	32	Z
9	9	33	b
10	Α	34	d
11	В	35	f
12	С	36	h
13	D	37	n
14	E	38	r
15	F	39	t
16	G	40	v
17	Н	41	١
18	J	42	?
19	К	43	{
20	L	44	}
21	М	45	<
22	N	46	>
23	Р		

Table 2: Lists for encoding and decoding of marking.

13 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3rd edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
<i>T</i> > 220 °C	30 s to 70 s
<i>T</i> > 230 °C	min. 10 s
<i>T</i> > 245 °C	max. 20 s
<i>T</i> ≥ 255 °C	-
peak temperature T _{peak}	250 °C +0/-5 °C
wetting temperature T_{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

 Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

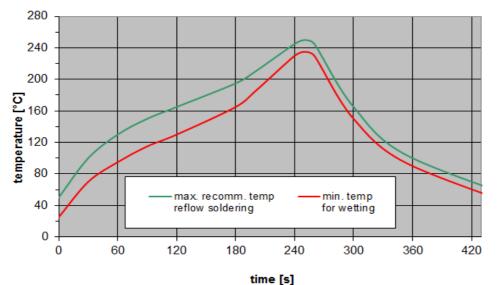


Figure 12: Recommended reflow profile for convection and infrared soldering – lead-free solder.

14 ESD protection of SAW filters

SAW filters are Electro Static Discharge sensitive devices. To reduce the probability of damages caused by ESD, special matching topologies have to be applied.

In general, "ESD matching" has to be ensured at that filter port, where electrostatic discharge is expected.

Electrostatic discharges predominantly appear at the antenna input of RF receivers. Therefore, only the input matching of the SAW filter has to be designed to short circuit or to block the ESD pulse.

Below three figures show recommended "ESD matching" topologies.

For wide band filters the high-pass ESD matching structure needs to be at least of 3rd order to ensure a proper matching for any impedance value of antenna and SAW filter input. The required component values have to be determined from case to case.

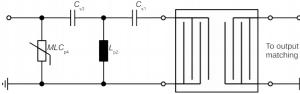


Figure 13: MLC varistor plus ESD matching.

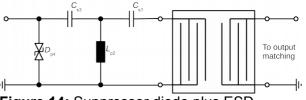


Figure 14: Suppressor diode plus ESD matching.

In cases where minor ESD occur, following simplified "ESD matching" topologies can be used alternatively.

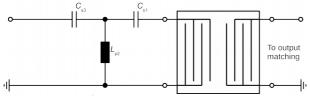


Figure 15: 3rd order high-pass structure for basic ESD protection.

In all three figures the shunt inductor L_{p2} could be replaced by a shorted microstrip with proper length and width. If this configuration is possible depends on the operating frequency and available PCB space.

Effectiveness of the applied ESD protection has to be checked according to relevant industry standards or customer specific requirements.

For further information, please refer to RF360 Application report: **"ESD protection for SAW filters".** This report can be found under <u>https://rffe.qualcomm.com</u>.

15 Annotations

15.1 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

15.2 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

16 Cautions and warnings

16.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under https://rffe.qualcomm.com/.

16.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

16.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

16.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Dimensions do not include burrs.

Projection method

Unless otherwise specified first-angle projection is applied.



17 Important notes

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